

PROGRAM-AT-A-GLANCE

wonday, 5	Julie		
07:00		Breakfast	
07:45 - 08:15		Welcome	
08:15 - 08:55	Plenary Spe	eaker I - Cherie R. K	lagan, Ph.D.
00.10 00.00	Univer	sity of Pennsylvania	a, USA
08:55 - 10:15	Session 1	- Microsystems for	Biosensing
10:15 - 10:44	Break	k and Tabletop Inspe	ection
10:44 - 10:45	Wen Ko Technic	al Leadership Award	Announcement
10:45 - 11:15		Invited Speaker I	
10.45 - 11.15	Alissa M. Fitz	gerald, Ph.D., AMFit	zgerald, USA
11:15 - 12:15	Session 2 - Inc	dustrial, Higher TRL	Microsystems
12:15 - 12:20	Oliv	er Brand Remembra	ance
12:20 - 12:45	Post	ter Preview - Sessi	on 1
12:45 - 14:15		Networking Lunch	
14:15 - 16:45	Poster Sessi	on 1 - Contributed a	nd Late News
Tuesday, 4 June			
Tuesuay, 4	Julie		
07:30	Julie	Breakfast	
-		Announcements	
07:30	Plenary Spea		
07:30 08:00	Plenary Spea E	Announcements aker II - Tobias Kipp	- -
07:30 08:00 08:05 - 08:45	Plenary Spea E Session 3 - Reso	Announcements aker II - Tobias Kipp EPFL, SWITZERLAN	o and Micromotors
07:30 08:00 08:05 - 08:45 08:45 - 09:45	Plenary Spea E Session 3 - Reso Breat	Announcements aker II - Tobias Kipp EPFL, SWITZERLANI nators, Oscillators	and Micromotors
07:30 08:00 08:05 - 08:45 08:45 - 09:45 9:45 - 10:14 10:14 - 10:15	Plenary Spea E Session 3 - Reso Breat	Announcements aker II - Tobias Kipp EPFL, SWITZERLANI nators, Oscillators and Tabletop Inspe	and Micromotors
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Monday, 3 June

19:00 - 22:00

Banquet

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07:15	Women in MEMS Breakfast
07:30	Breakfast
08:10	Announcements
08:15 - 08:55	Plenary Speaker III - Christopher J. Cannova M.D.
	Aligned Orthopedic Partners, USA
08:55 - 10:15	Session 5 - Medical MEMS
10:15 - 10:44	Break and Tabletop Inspection
10:44 - 10:45	Mark Shannon Grand Challenges Award Announcement
10:45 - 11:15	Invited Speaker III
10.45 - 11.15	Joshua Windmiller, Ph.D., Dexcom, USA
11:15 - 12:15	Session 6 - Novel Devices
12:15 - 13:00	Poster Preview - Session 2 Commercial Posters
13:00 - 14:30	Networking Lunch
14:30 - 17:00	Poster Session 2 - Contributed and Late News
17:00 - 18:30	Free Time
18:30 - 19:30	Poster Session 3 and Reception
	Commercial & Open Posters
20:00 - 22:00	Rump Session

Wednesday, 5 June

Thursday, 6 June

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07:30	Breakfast
08:10	Announcements
08:15 - 08:55	Plenary Speaker IV - Evelyn N. Wang, Ph.D. ARPA-E, USA
08:55 - 09:55	Session 7: Novel Devices and Processes
09:55 - 10:25	Break and Tabletop Inspection
10:25 - 10:55	Invited Speaker IV Ginel Hill, SiTime, USA
10:55 - 11:55	Session 8 - Late News
11:55 - 12:30	Award Ceremony and Closing Remarks
12:30 - 14:00	Networking Lunch
14:00	Workshop Adjourns

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All photos Courtesy of the Hilton Head Island Visitor & Convention Bureau

GENERAL INFORMATION

Wireless Internet Service

Wireless Internet will be available in the Workshop meeting space in the Sonesta Resort.

- · Select "Sonesta Guest" from the list of available networks
- · Scroll down to the third option "High Speed"



We ask that you limit your usage to be considerate of other attendees and please logout once you are finished. There is a bandwidth limit of 2 Mbps per device.

Meeting Room Logistics

Please contact the Workshop Registration Desk if you find the temperature in the room are uncomfortable, or you are unable to hear or see because of equipment difficulties.

Name Badges

All attendees, and their guests, must wear their name badge at all times to gain admission to all sessions and social functions.

Job Board

The Job Board will be located near the Workshop Registration Desk.

Chimes

The chimes will ring five minutes before the end of each scheduled break. The sessions will begin on time, so please return to the meeting room when you hear the chimes.

Hilton Head on Social Media

Don't forget to follow and tag us on our social media platforms.



Please be courteous and don't share unauthorized photos, defamatory statements, et cetera.

GUEST PACKAGES

Guest meal packages are available for purchase for all guests of attendees. The package includes the Sunday Welcome Reception, Guest Breakfast (Jasper Room, Second Floor, Monday - Thursday, 07:30 - 10:00), Lunches, and the Tuesday Banquet. Please visit the Workshop Registration Desk if you would like to purchase a guest package. Guests and children will not be admitted to social events without a badge. A name badge is required for anyone to attend the meal functions. Children under 6 are free but require a name badge. Please register them as well if you have not already done so.

SOCIAL EVENTS

Name badges are required for all Social Events, including guests and children.

Sunday Welcome Reception

The Welcome Reception will be held Sunday evening, 18:00 - 21:00 outside in the Pavilion.

Tuesday Banquet

The Banquet will be held on Tuesday evening, 19:00 - 22:00 outside in the Pavilion and is sponsored in part by:



Beach Volleyball

The Beach Volleyball tournament, sponsored by Analog Devices, will be held on Tuesday afternoon between 15:00 and 18:00. All levels of play will be integrated into this fun afternoon. Analog Devices will be supplying refreshments, so come

out and play, or just come watch the fun. If you are interested in joining, please sign-up at the Workshop Registration Desk so we may get a headcount for refreshments.



Women in MEMS Breakfast

The Women in MEMS Breakfast will be on Wednesday from 07:15 - 08:10 in the Savannah Jr. Ballroom. Come meet new faces, catch up with old friends, and make connections. Students and first-time attendees are especially encouraged to attend and join the Women in MEMS Network. Breakfast will be served in the room.

Student Networking Events

Lunches - During lunch each day, there will be reserved tables in the outdoor pavilion for students to network and socialize.

Sandcastle Building – Join us Tuesday at 14:00 on the beach and compete in Sandcastle Building. You will form teams of students from different universities and compete for prizes and glory!

Scavenger Hunt – Join us on the student Slack channel (<u>https://hiltonheadworkshop.slack.com/</u>) for a workshop scavenger hunt!



ORGANIZING COMMITTEE

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THE TRANSDUCER RESEARCH FOUNDATION (TRF) is a non-profit organization whose purpose is to stimulate research in science and engineering, and to foster a technical community that promotes the exchange of ideas and information and provides career development opportunities. With emphasis on technologies related to transducers, microsystems, and nanosystems, these objectives will be pursued through a variety of activities and initiatives, including but not limited to the following:

- 1. Sponsoring and organizing regional, national, and international conferences, meetings, workshops, and short courses in transducers, microsystems, and nanotechnology. Net proceeds raised during the sponsored events are retained and utilized by TRF to support future activities and initiatives.
- 2. Raising and administering the distribution of funds with the purpose of enhancing and encouraging advances in the fields of transducers, microsystems, and nanotechnology.
- 3. Fostering liaison between academic, industry, and government organizations to enhance cooperation and collaboration.
- 4. Providing mentoring and continuous education to students and young professionals in science, engineering, technology, and related fields.
- 5. Supporting research in the fields of microfabricated sensors, actuators, and mechanical components, as well as microsystems, nanosystems, and the underlying technologies that advance all of these fields, through scholarships, seed grants for new conferences and workshops, grants for student travel to conferences, and other means.

TRF welcomes inquiries from individuals and groups who wish to apply for TRF sponsorship of proposed topical workshops and conferences that are consistent with the TRF mission. If your organization would like to explore any of the options for TRF sponsorship or student travel grants, please contact a TRF Officer/Director, or email us at info@transducer-research-foundation.org for further information.

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COMMERCIAL SUPPORT

Special acknowledgement to the Transducer Research Foundation, Inc. for their educational grant funding support of this Workshop.



The Transducer Research Foundation, Inc. would also like to thank the following companies for their support, encouragement, and involvement in the 2024 Solid State Sensors, Actuators, and Microsystems Workshop.

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Established in 2003, A.M. Fitzgerald & Associates, LLC ("AMFitzgerald") provides expert MEMS product development services and solutions, including: custom MEMS design, emerging technology development, simulation, process integration, MEMS prototype fabrication, package and test, foundry selection and transfer with support through production, and strategy consulting.

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IEEE Micro Electro Mechanical Systems (MEMS) Technical Community will keep you abreast of the latest in MEMS ideas, designs, and manufacturing methodologies, many of which could very well spark new thinking and enable new capabilities in a myriad of IEEE fields. MEMS is an enabling technology harnessing the benefits of miniaturization in physical domains beyond the electrical and found in billions of devices today.

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The Viterbi School of Engineering has at least four tenure track faculty members (in AME, BME and ECE departments) whose main research thrusts are in MEMS including but not limited to acoustic, biomedical, energy-harvesting, microfluidic and wearable MEMS.

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IEEE Micro Electro Mechanical Systems (MEMS) Technical Community will keep you abreast of the latest in MEMS ideas, designs, and manufacturing methodologies, many of which could very well spark new thinking and enable new capabilities in a myriad of IEEE fields. MEMS is an enabling technology harnessing the benefits of miniaturization in physical domains beyond the electrical and found in billions of devices today.

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LioniX International develops and produces customized MEMS solutions, including process development, mask design and prototyping, from proof-of-principle devices through medium-volume production.

EXHIBITORS

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EXHIBITORS

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SUSS MicroTec Inc.7

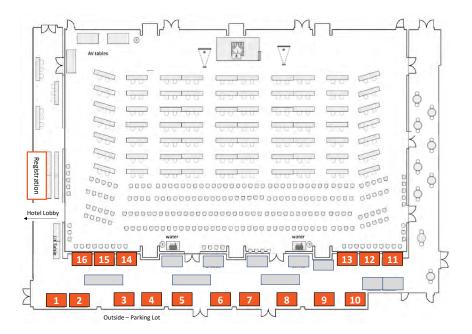
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SUSS MicroTec provides solutions for semiconductor microstructuring, works on 3D integration, nanoimprint lithography, MEMS and LED processes and supports over 8,000 systems worldwide.



Tabletop Floor Plan

Santee Ballroom Foyer



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AWARDS

DENICE DENTON MENTORSHIP AWARD

The Hilton Head Workshop is pleased to announce the 2024 Denice Denton Mentorship Award. This award recognizes long-term mentors with a proven record of mentoring researchers and engineers in the areas of interest to TRF.

The award is given in honor of Denice Denton (1959 - 2006), who earned her BS, MS and PhD in electrical engineering from the Massachusetts Institute of

Technology, and then went on to a groundbreaking career in academia.

She was the first female engineer to receive tenure as a faculty member at the University of Wisconsin -Madison. At age 37 she was appointed Dean of Engineering at the University of Washington, one of the youngest as well as the first female dean of a top-ranked



engineering program. While at UW, she was awarded the Presidential Award for Excellence in Science, Mathematics and Engineering Mentoring. At 45 she was selected as the Chancellor of the University of California, Santa Cruz, the youngest and the first openly gay person to be appointed as Chancellor in the University of California system.

Denton was a prolific and influential mentor who not only supported colleagues but also remedied the marginalization of those not in positions of privilege and power, using strategies she developed while surmounting daunting professional obstacles of her own. She founded and sustained informal, lively peer support groups, made connections to advocates in positions of power, sought out and shared information about institutional procedures, and even helped with fundraising for legal fees in some cases. She lived out her ideal of institutions in which people could thrive personally as well as professionally.

In a speech to the National Academies, former Dept. of Health and Human Services Secretary Donna Shalala said of Denton, "She was bigger than life. She opened doors and stood in them to let others through."

MARK SHANNON GRAND CHALLENGES AWARD

The Hilton Head Workshop is pleased to announce the 2024 Mark Shannon Grand Challenges Award. This award recognizes the long-term contributions of members of our technical community with a vision to address humanity's pressing issues.

The award is given in honor of Mark A. Shannon (1955 - 2012), who earned his BS, MS, and PhD degrees at the University of California, Berkeley, and was on the Mechanical and Systems Engineering faculty of the University of Illinois Urbana-Champaign.

Shannon was renowned for developing nanoscale, microscale, and mesoscale technologies that addressed the grand challenges of water purification and desalination, micro-fabrication, medicine, and energy production. His mission was to bring attention to and solve challenges with the world's highly



vulnerable freshwater resources. To this end, he invented new micro- and nanofabrication methods that utilize electric fields, plasmas, and chemistry to create new NEMS, MEMS, and mesoscale energetic devices and water purification systems. In particular, he was co-inventor of a "molecular gate" that can move and filter materials at the molecular level.

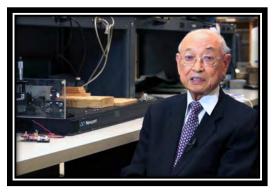
A pillar of our Hilton Head community, his international reputation and passion for his work was evident whether he was teaching students or testifying before Congress, and his energy and tenacity attracted others from around the world to share his vision and work to solve society's problems. By his side always was his wife Mona--the first and only love of his life--including at numerous Hilton Head meetings where she warmly created community. For those lucky enough to work with or know him, Shannon was best known for an unbridled enthusiasm for life, dedication and love for his family, and devotion to his students, even while gravely ill with amyotrophic lateral sclerosis (ALS), also known as Lou Gehrig's disease. In commemorating Shannon's passing, former UIUC Department Head Placid Ferreira shared: "A true visionary, Mark was an extraordinary person who dedicated his work and efforts to our students. He was an inspiration to all of us, and we will always remember his generosity and strength."

WEN KO TECHNICAL LEADERSHIP AWARD

The Hilton Head Workshop is pleased to announce the 2024 Wen Ko Technical Leadership Award. This award recognizes researchers with an outstanding track-record of technical leadership and innovation in areas of interest to the TRF.

The award is given in honor of Wen Hsiung Ko (1923 - 2017), a member of the Electrical Engineering faculty of Case Western Reserve University (CWRU) from 1959 to his retirement in 1993.

A native of mainland China, Ko moved to Taiwan in the late 1940s and then to Cleveland in 1954, where he earned both his MS (1956) and PhD (1959) from the Case Institute of Technology.



An innovator in both electrical and biomedical engineering, he was a pioneer in microsensors, actuators, integrated microsystems, medical implants, telemetry and packaging. His body of work on physical and chemical (gas) microsensors in the early 1970s is one of the earliest efforts in the field. In the mid-1960s, his group demonstrated the first implantable muscle control system in living subjects.

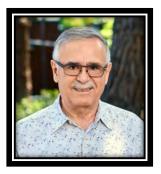
A light to generations of young engineers, he advised more than 150 MS and PhD students. He established and led the Electronics Design Center at CWRU and was a Fellow of IEEE Biomedical Engineering Society and the American Institute of Medical and Biological Engineering. He was one of the founders of the Transducers Research Foundation and the Hilton Head Workshop series and served as TRF president from 1987 to 2004.

After retirement, Ko remained a research-active emeritus professor for another 11 years, serving as PI on an NIH R21 grant at the age of 89! Ko's children noted, "His spirit and intellect continued to be strong and curious up to the end."

JANUSZ BRYZEK ABUNDANCE THROUGH MEMS AWARD

The Janusz Bryzek Abundance through MEMS award seeks to recognize graduate or undergraduate students whose work best exemplifies the application of MEMS to Abundance. Abundance refers to a future in which all of humanity has access to clean water, food, energy, health care, housing, education and everything else to live an abundant fulfilling life due to rapid developments in exponential technologies including MEMS. Janusz Bryzek was a pioneering and prolific MEMS entrepreneur who started 11 companies and was committed to the vision of Abundance. This award, honoring Janusz' legacy, will recognize emerging researchers in MEMS and related fields whose work significantly contributes to the vision of Abundance.

Dr. Janusz Bryzek was a world-renowned pioneer in the field of micro-electromechanical systems (MEMS), founding and commercializing his MEMS passion vis-à-vis 11 companies over his 40 plus year career ... from pressure sensors to multiplexers, IMUs to ultrasonic imagers. An optimistic technology enthusiast, he envisioned the abundance of ubiquitous low-cost MEMS devices as a means of improving the quality of lives globally. As such, he operated at the convergence of MEMS, Entrepreneurism, and Abundance.





MICROSYSTEMS & NANOENGINEERING/SPRINGER NATURE BEST PAPER AWARD BENEFACTOR

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SPECIAL EVENTS

WORKSHOP 1: MEMS KNOW HOWE

Sunday - 10:00 - 15:00 - Savannah Jr. Ballroom

Professor Roger Howe, a leading figure in the field of Micro-Electro-Mechanical Systems (MEMS), is set to retire from Stanford University this year. In honor of his retirement, a symposium is being organized to celebrate his transformative contributions to MEMS technology.

The event will feature talks from Professor Howe's colleagues and students, who will highlight the various facets of his impact on the MEMS community. Specific focus areas will include surface micromachining, resonators, oscillators, inertial sensors, self-assembly processes, adhesion in microstructures, optical MEMS, biosensors, and other applications. The symposium aims to acknowledge Professor Howe's enduring influence on MEMS, offer insights into key advancements from both academia and industry, and inspire a new wave of pioneers in the field.

WORKSHOP 2: SMALL-SCALE ROBOTS: FROM ONE TO A SWARM Sunday - 11:00 - 17:00 – Charleston Room, 2nd Floor

The research on small-scale robots has benefited tremendously from prior technological advances in MEMS. This journey started in 1980s where the vision of silicon chip-based robots with onboard sensors, actuators, and power supplies was proposed. Today, the challenge remains: how do we power these micro marvels and equip them with sufficient force to perform their tasks? The initial segment of this workshop will explore cutting-edge sensors and actuators, novel manufacturing methods, and creative strategies to address the energy limitations inherent in small-scale robotic systems.

The progress in small-scale robotics opens a dialogue about the creation of artificial agents that emulate the capabilities of their biological counterparts. In nature, the collective behaviors of simple agents—like ant colonies, bee hives, and schools of fish—illustrate how local interactions can lead to complex group dynamics, where the system as a whole is greater than the sum of its parts. Small-scale robots, with their compact dimensions and cost-effectiveness, serve as ideal platforms for exploring embodied and swarm intelligence. The workshop's second session will convene experts in swarm robotics, with a particular emphasis on micro-robots, to highlight the latest progress from theory to real-world applications in swarm design, fabrication, actuation, and coordination

SEMI MSIG INDUSTRY SESSION: NAVIGATING THE TRANSITION TO INDUSTRY Tuesday - 14:00 - 16:00 - Santee Ballroom

Join us for an immersive Industry Session designed to help graduate students navigate the transition from academia to industry. This event is hosted by SEMI MEMS and Sensors Industry Group (MSIG), a trade organization that brings together key players from across the ecosystem to address common challenges, explore emerging trends, and drive industry growth.

Gain practical advice, success strategies, and learn about the nuances of industry roles that are often overlooked in academia, as well as the variety of roles both in and out of the fab. Learn how to leverage your academic background while adapting to the dynamic demands of the industry. Engage with seasoned industry executives as they share firsthand experiences and advice. Participate in breakout sessions facilitated by rising stars in the industry. Don't miss this exclusive opportunity to expand your professional network, gain invaluable industry insights, and chart a successful career path in the MEMS and sensors sector.

BEYOND TECHNICAL EXPERTISE: DEALING WITH SOURCES OF PERSONAL AND PROFESSIONAL STRESS Tuesday - 14:00 - 16:00 - Savannah Jr. Ballroom

We use short dramatizations supplemented with extensive discussion to explore stressful non-technical issues that often arise in the high-tech life. Specifically, we focus on three topics: power imbalance during peer review, when a junior investigator is asked to review a paper by a senior person, and there is a question of originality of the work; microaggressions, behaviors that create personal discomfort, whether intended or accidental; and the imposter syndrome, feelings of personal or professional inadequacy that can arise when exploring uncharted territory.

WEDNESDAY RUMP SESSION

Wednesday - 20:00 - 22:00 - Santee Ballroom

The 40th anniversary rump session hopes to capture classic aspects of the Hilton Head experience. To kick things off, attendees will be asked to test their knowledge on all aspects of microsystems, and Hilton Head. Try to find yourself in a diverse group to maximize your success! Amidst the trivia, serious discussion will be had on important topics in our field. Of course, no anniversary would be complete without special guests and toasts. As usual, snacks and beverages will be provided. So, you bring the Chips (Act), we will bring the salsa. This session is open to all attendees.

Sunday, 2 June Workshop 1 MEMS Know Howe

10:00 HOWE MEMS REALLY TOOK OFF Kurt Petersen, Silicon Valley Band of Angels, USA

> MICROFABRICATED ELECTROSTATIC COMB DRIVE William Tang, University of California, Irvine, USA

HOWE POLYSILICON SURFACE MICROMACHINING TRANSFORMED INERTIAL MEMS Michael Judy, Consultant, USA

INTEGRATION OF MEMS AND CMOS Gary Fedder, Carnegie Mellon University, USA

ADHESION AND ADHESION REDUCTION PROCESSES IN SURFACE MICROMECHANICAL STRUCTURES Roya Maboudian, University of California, Berkeley, USA

MICROASSEMBLY PROCESSES Karl Bohringer, University of Washington, USA

- 12:00 Lunch
- 13:00 MEMS RESONATORS AND OSCILLATORS Clark Nguyen, University of California, Berkeley, USA

HOWE SILICON MEMS RESONATORS BEGAN THE PATH TO TIMING PRODUCTS Tom Kenny, Stanford University, USA

MEMS VIBRATORY GYROSCOPES ARE BECOMING 3D AND ATOMICALLY PRECISE

Andrei Shkel, University of California, Irvine, USA

OPTICAL MEMS Olav Solgaard, Stanford University, USA

APPLICATION OF ULTRATHIN ALD PLATES

Igor Bargatin, University of Pennsylvania, USA

SIMPLIFYING BIOASSAY DEVELOPMENT WITH QES Chaitanya Gupta, Probius, USA

SUMMARY AND WRAP-UP Roger Howe, Stanford University, USA

15:00 Adjourn

Workshop 2 Small-Scale Robots: From One to a Swarm

- 11:00 Morning Session
- 13:00 Lunch
- 15:30 Afternoon Session
- 17:00 Adjourn

Speakers:

Kristofer Pister, University of California, Berkeley, USA Amit Lal, Cornell University, USA Di Ni, Princeton University, USA Steven Ceron, Massachusetts Institute of Technology, USA Ronald Heisser, Massachusetts Institute of Technology, USA

18:00 - Registration and Welcome Reception 21:00





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Topics of Particular Interest

Including, but not limited to:

- Micro-nano sensors and actuators
- MEMS and NEMS materials, fabrication and packaging
- Applied sciences of micro-nano systems
- Micro-nano mechanics, structures and modeling

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Monday, 3 June

07:00 Breakfast

07:45 Welcome

TRF President - Reza Ghodssi, University of Maryland **Workshop Chair** - Jenna Chan, DEVCOM Army Research Laboratory **Program Chair** - Swaminathan Rajaraman, University of Central Florida

Plenary Speaker I

Session Chair: Shawana Tabassum, University of Texas, Tyler, USA

08:15 IoT4Ag AGRICULTURAL LEAF AND SOIL SENSORS Cherie R. Kagan, Ph.D., Roy H. Olsson, and Kevin T. Turner University of Pennsylvania, USA

Session 1 - Microsystems for Biosensing

Session Chair: Igor Paprotny, University of Illinois, Chicago, USA

08:55 INGESTIBLE DEVICE FOR NOISE-RESILIENT BIOIMPEDANCE MONITORING IN GASTROINTESTINAL TRACT

Brian M. Holt¹, Justin M. Stine¹, Luke A. Beardslee¹, Jay Pasricha², and Reza Ghodssi¹ ¹University of Maryland, USA and ²Mayo Clinic, USA,

09:15 MICROFABRICATION AND CHARACTERIZATION OF A NOVEL 3D MITOCHONDRIA BIOSENSOR

Randall James, Isaac Johnson, Ji Chang, Jorge Manrique Castro, and Swaminathan Rajaraman *University of Central Florida, USA*

09:35 ELECTRONIC-FREE TRACEABLE SMART CAPSULE FOR GASTROINTESTINAL MICROBIOME SAMPLING

Devendra Sarnaik, Sina Nejati, Sarath Gopalakrishnan, Venkat Kasi, Akshay Krishnakumar, Samuel Hyde, Robyn McCain, Kinam Park, Jay S. Johnson, and Rahim Rahimi *Purdue University, USA*

09:55 ULTRA-SENSITIVE ON-CHIP GRAPHENE-BASED ELECTRO-OPTIC SENSOR ARRAYS FOR MULTIPLEXED NEURAL SIGNAL DETECTION

Xiang Li, Zabir Ahmed, Harshvardhan Gupta, Kanika Sarna, Vishal Jain, and Maysam Chamanzar *Carnegie Mellon University, USA*

10:15 am Break and Tabletop Inspection

10:44 am Wen Ko Technical Leadership Award Announcement

Invited Speaker I

Session Chair: Kirsten Kaplan, Facebook, USA

10:45 FORTY YEARS OF MEMS INNOVATION AT HILTON HEAD WORKSHOP: FROM EMERGING TECHNOLOGIES TO COMMERCIAL PRODUCTS Alissa M. Fitzgerald, Ph.D. AMFitzgerald & Associates, LLC, USA

Session 2 - Industrial, Higher TRL Microsystems

Session Chair: Thomas Li, NXP Semiconductors, USA

11:15 CARDIOPULMONARY AUSCULTATION SYSTEM ENABLED BY A NOVEL BEYOND-RESONANCE SENSING ACCELEROMETER

Tzeno Galchev¹, Longwei Xiao², Wenyong Zhang², Haozhe Dong², Jianglong Zhang¹, James Lin¹, Zhengxin Zhao¹, Adam Spirer¹, Jin Peng³, Hua Jiang⁴, Khiem Nguyen¹, and Sam Zhang¹ ¹Analog Devices Inc., USA, ²Catron Inc., USA, ³Sichuan University, CHINA, and ⁴Sichuan Provincial People's Hospital, CHINA,

11:35 A MEMS-BASED ANALOG COMPUTER FOR EDGE AI COMPUTING

David Lin¹, Johan M. Reimann¹, Dorin E. Calbaza¹, Robert J. MacDonald¹, Zhihui Yang¹, Abdallah K. Alzubi², Mohammad S. Megdadi², and Fadi M. Alsaleem² ¹*GE Aerospace Research, USA and* ²*University of Nebraska-Lincoln, USA*

11:55 NESTED-MEMS TEMPERATURE COMPENSATED SINGLE-CRYSTALLINE SILICON OSCILLATOR

Amir Rahafrooz, Diego Emilio Serrano, Ryan Hennessy, William McDonald, Duane Younkin, Kieran Nunan, Stanley Che, and Ijaz Jafri *Panasonic Massachusetts Laboratory, USA*

12:15 Oliver Brand Remembrance

12:20 Poster Preview – Session 1

Session Chairs: Hengky Chandrahalim, Air Force Institute of Technology, USA Siddhartha Ghosh, Northeastern University, USA

- 12:45 Networking Lunch
- 14:15

Poster Session 1

Session Chair: Reza Ghodssi, University of Maryland, USA

14:15Contributed and Late NewsSee page 13 for listing of poster presentations

16:45 pm End of Day



Tuesday, 4 June

- 07:30 Breakfast
- 08:00 Announcements

Plenary Speaker II

Session Chair: Amit Lal, Cornell University, USA

08:05 HYBRID LOW LOSS INTEGRATED PHOTONICS: FROM CHIPSCALE FREQUENCY COMBS, FREQUENCY AGILE LASERS, ERBIUM AMPLIFIERS TO CRYOGENIC QUANTUM INTERCONNECTS

> Tobias Kippenberg, Ph.D. Swiss Federal Institute of Technology Lausanne (EPFL), SWITZERLAND

Session 3 - Resonators, Oscillators and Micromotors

Session Chairs: Azadeh Ansari, Georgia Institute of Technology, USA and Vikrant Gokhale, Navy Research Laboratory, USA

08:45 Q-ENHANCEMENT OF PIEZO-ON-SILICON MEMS RESONATORS THROUGH MODE-COUPLING AND TOPOLOGICAL TANK CONFIGURATIONS Suaid Tariq Balghari, Abid Ali, and Frederic Nabki Ecole de Technologie Superieure, CANADA

09:05 ULTRA-STABLE MEMS OSCILLATOR WITH 42 PPT FRACTIONAL FREQUENCY STABILITY AT 85 SECONDS Jintark Kim¹, Rakibul Islam¹, Jiheng Jing¹, Jie Yan¹, Gabrielle Vukasin², Ryan Kwon², Saurabh Saxena^{1,3}, Thomas W. Kenny², Pavan K. Hanumolu¹, and Gaurav Bahl¹ ¹University of Illinois, Urbana-Champaign, USA, ²Stanford University, USA, and ³Indian Institute of Technology, INDIA

09:25 ANALOG MICRO DELTA (μΔ) MOTOR: COMPLIANT MECHANISM ENABLED MEMS BIDIRECTIONAL TRANSMISSION-CAPABLE GAP CLOSING ARRAY Alexander N. Alvara, Yichen Liu, Liwei Lin, and Kristofer S. J. Pister University of California, Berkeley, USA

9:55 am Break and Tabletop Inspection

10:14 am Denice Denton Mentorship Award Announcement

Invited Speaker II

Session Chair: Ravi Selvaganapathy, McMaster University, CANADA

10:15 CHANGING THE COURSE OF HEART FAILURE DISEASE MANAGEMENT USING MEMS – A CARDIOMEMS STORY Michael A. Fonseca, Ph.D.

StethX Microsystems, USA

Session 4 - Chemical and Environmental Sensing

Session Chairs: Daniela Diaz-Alonso, Center for Engineering and Industrial Development (CIDESI), MEXICO and Rahim Rahimi, Purdue University, USA

10:45 AN ELECTROLYTIC-INDUCED BUBBLE-BASED DISSOLVED CO₂ SENSOR

Steven Tran, Seungbeom Noh, and Hanseup Kim University of Utah, USA

11:05 MULTI-MODAL MEMS SENSING MODULE FOR EXTRATERRESTRIAL OCEANOGRAPHIC EXPLORATION Zhijian Hao¹, Yue Zheng¹, Ethan W. Schaler², and Azadeh Ansari¹ ¹Georgia Institute of Technology, USA and ²Jet Propulsion Laboratory, California Institute of Technology, USA,

11:25 PAPER-BASED WEARABLE MOIST-ELECTRIC GENERATORS WITH EFFICIENT ATMOSPHERIC WATER CAPTURE Yang Gao, Anwar Elhadad, and Seokheun Choi

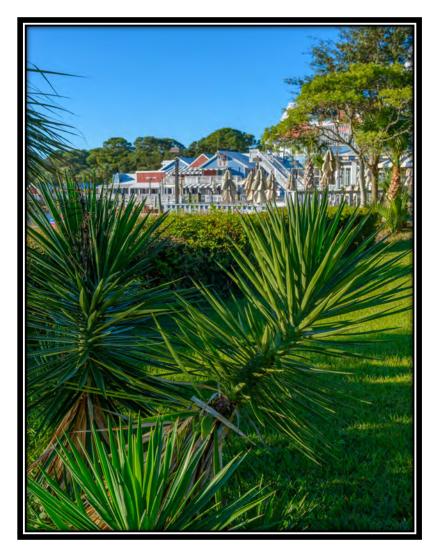
State University of New York, Binghamton, USA

- 11:45 Hilton Head Education, History, and Conservation Talk The Civil War on Hilton Head Island: Local History, National Impact, Enduring Legacy Jan McKelvey Lean Ensemble Theater, USA
- 12:15 Networking Lunch
- 13:30
- 14:00 SEMI MSIG Industry Session:
- 16:00 Navigating the Transition to Industry
- 14:00 Workshop: Beyond Technical Expertise: Dealing with
- 16:00 Sources of Personal and Professional Stress

- 14:00 Recreational Activities (on your own)
- 19:00
- 18:00 Student Sandcastle Building Event
- 19:00

19:00 - Banquet

22:00



Wednesday, 5 June

- 7:15 am Women in MEMS Breakfast (Savannah Jr. Ballroom)
- 7:30 am Breakfast
- 8:10 am Announcements

Plenary Speaker III

Session Chair: Reza Ghodssi, University of Maryland, USA

08:15 SENSORS, ROBOTS, AND AI FEEDBACK DATA LOOPS: POWERING JOINT REPLACEMENT SURGERIES OF THE FUTURE

<u>Christopher J. Cannova, M.D.</u> Aligned Orthopedic Partners, USA

Session 5 - Medical MEMS

Session Chairs: Kevin Daniels, University of Maryland, USA and Virgilio Valente, Toronto Metropolitan University, CANADA

08:55 AN APPROACH FOR 3D MICROPRINTING OF SOFT ROBOTIC BIOPSY TOOLS AT 1 FRENCH LENGTH SCALES VIA *EX SITU* DIRECT LASER WRITING

Sunandita Sarker^{1,2}, Declan Fitzgerald¹, Zachary Ferraro¹, Olivia M. Young¹, Bailey M. Felix¹, and Ryan D. Sochol¹ ¹University of Maryland, USA and ²University of Massachusetts, USA

- 09:15 FLEXIBLE MICROINJECTOR FOR RAPID LOCALIZED DRUG DELIVERY FROM INGESTIBLE DEVICES Joshua A. Levy, Michael A. Straker, and Reza Ghodssi University of Maryland, USA
- 09:35 MAGNETIC FIELD SENSING WITH A MINIATURE ELECTRO-OPTIC SENSOR FOR INTERVENTIONAL MAGNETIC RESONANCE IMAGING

Alp A. Derin¹, Abhiram Pulavarthi¹, Jordan L. Edmunds², Jack Guida¹, Siddhartha Ghosh¹, and Soner Sonmezoglu¹ ¹Northeastern University, USA and ²University of California, Berkeley, USA 09:55 ULTRASOUND-BASED TELEMETRY OF IMPLANTED MICROFLUIDICS FOR INTRACRANIAL PRESSURE SENSING Cecilia A. Luna^{1,2}, Saeyoung Kim², Adeoye Olomodosi^{1,2}, Nicholas Au Yong^{1,2}, Brooks D. Lindsey^{1,2}, and David R. Myers^{1,2} ¹Emory University, USA and ²Georgia Institute of Technology, USA,

- 10:15 Break and Tabletop Inspection
- 10:44 Mark Shannon Grand Challenges Award Announcement

Invited Speaker III

Session Chair: Shaurya Prakash, Ohio State University, USA

10:45 EMPOWERING PEOPLE TO TAKE CONTROL OF HEALTH Joshua Windmiller, Ph.D. Dexcom, USA

Session 6 - Novel Devices

Session Chair: Farnaz Niroui, Massachusetts Institute of Technology, USA

11:15 POSS-ENABLED MECHANICAL ENHANCEMENT FOR 3D-NANOPRINTED HIGH-ASPECT-RATIO MICROINJECTION NEEDLES

Adira Colton¹, Sunandita Sarker¹, A. Muhaymin Chowdhury¹, Prableen Chowdhary², Joshua A. Levy¹, Katie L. Rusland¹, Reza Ghodssi¹, Rachel Brewster², Kinneret Rand-Yadin³, and Ryan D. Sochol¹ ¹University of Maryland, College Park, USA, ²University of Maryland,

Baltimore County, USA, and ³SeeTrue Technology, LLC, USA

11:35 AFTER 90 YEARS: CMOS-BASED HAFNIA-ZIRCONIA NANOMECHANICAL RESONATOR EXCEEDING AT-CUT QUARTZ TEMPERATURE STABILITY

Troy Tharpe, Moumita Chakraborty, and Roozbeh Tabrizian *University of Florida, USA*

11:55 ULTRACOMPACT AND HIGH-GAIN THIN-FILM BULK ACOUSTIC RESONATOR MAGNETOELECTRIC ANTENNA ARRAY

Bin Luo¹, Xianfeng Liang¹, Huaihao Chen¹, Neville Sun¹, Hwaider Lin², and Nian X. Sun¹ ¹Northeastern University, USA and ²Winchester Technologies LLC, USA,

- 12:15 Poster Preview Session 2 Commercial Posters Session Chairs: Mary Beth Galanko Klemash, DEVCOM Army Research Laboratory, USA Swaminathan Rajaraman, University of Central Florida, USA
- 13:00 Networking Lunch
- 14:30

Poster Session 2

Session Chair: Jenna Chan, DEVCOM Army Research Laboratory, USA

- 14:30 Contributed and Late News
- 17:00 Free Time

Poster Session 3 and Reception Session Chair: Sina Askari, ECS/DARPA, USA

- 18:30 Commercial and Open Posters
- 20:00 Rump Session
- 22:00



Thursday, 6 June

- 07:30 Breakfast
- 08:10 Announcements

Plenary Speaker IV

Session Chair: Kari Moran, Naval Information Warfare Center Pacific, USA

08:15 MICRO INNOVATIONS, MACRO IMPACT: MEMS AT THE FOREFRONT OF OUR ENERGY FUTURE Evelyn N. Wang, Ph.D. ARPA-E, USA

Session 7 - Novel Devices and Processes

Session Chair: Logan Sorenson, HRL Laboratories, USA

08:55 FABRICATION OF SUPERHYDROPHOBIC STRUCTURES VIA AEROSOL JET PRINTING

Jace Rozsa¹, Ke Zhong¹, Dinesh K. Patel¹, Lining Yao², Mohammad F. Islam¹, and Gary K. Fedder¹ ¹Carnegie Mellon University, USA and ²University of California, Berkeley, USA

- 09:15 TRANSLATION AND ELECTRICALLY CONTROLLED ROTATION OF LARGE ZEBRAFISH EMBRYO BY ACOUSTIC TWEEZERS Baptiste Neff, Kianoush Sadeghian Esfahani, Akash Roy, Matin Barekatain, and Eun S. Kim University of Southern California, Los Angeles, USA
- 09:35 LOCALIZED AND CONFORMAL STRAIN ENGINEERING OF 2D MATERIALS FOR SCALABLE, FUNCTIONAL DEVICES Sarah O. Spector, Weikun Zhu, Alex Quach, Peter F. Satterthwaite, and Farnaz Niroui Massachusetts Institute of Technology, USA
- 09:55 Break and Tabletop Inspection

Invited Speaker IV

Session Chair: Vladimir Aksyuk, National Institute of Standards and Technology, USA

10:25 DECADES OF MEMS TIMING <u>Ginel C. Hill, Ph.D.</u>, Gary K. Giust, and Markus Lutz *SiTime Corporation, USA*

Session 8 - Late News

Session Chair: Kimberly Harrison, AMFitzgerald, USA

10:55 A NOVEL THIN FILM ENDOVASCULAR ELECTRODE ARRAY FOR MINIMALLY INVASIVE NEURAL RECORDING Brianna Thielen¹, Huijing Xu¹, Pradeep Selvan², Charles Liu¹, William J. Mack¹, Dong Song¹, and Ellis Meng¹ ¹University of Southern California, Los Angeles, USA and ²Lundquist Institute for Biomedical Innovation, USA

11:15 AN AGING COMPENSATED ALSCN-ON-SI BULK ACOUSTIC WAVE OSCILLATOR TOWARDS TACTICAL-GRADE CLOCK GENERATION

Banafsheh Jabbari, Shaurya Dabas, Dicheng Mo, Eitan. Hershkovitz, Honggyu Kim, and Roozbeh Tabrizian *University of Florida, USA*

11:35 INGESTIBLE BIOIMPEDANCE SENSING DEVICE FOR LOCALIZED FEEDBACK-DRIVEN DRUG DELIVERY Mateo W. Lim, Brian M. Holt, Joshua A. Levy, Justin M. Stine, Luke A. Beardslee, and Reza Ghodssi

University of Maryland, USA

- 12:10 Award Ceremony
- 12:10 Closing Remarks

Workshop Chair - Jenna Chan, DEVCOM Army Research Laboratory Program Chair - Swaminathan Rajaraman, University of Central Florida

- 12:45 Networking Lunch
- 14:15
- 14:15 Workshop Adjourns

Poster Presentations - Session 1

Contributed and Late News Posters Monday, 3 June 14:15–16:45

Chemical or Biological Sensors, Actuators or Systems

MP-01 A HIGHLY SENSITIVE FLEXIBLE AG NPS/MWCNTS/NAFION-RU(NH₃)₆^{3+/2+} ELECTRODE WITH SU-8 MICROPILLARS FOR REAL-TIME HYDROGEN SULFIDE MONITORING IN LIQUIDS Chih-Hsiang Su¹, Mu-Yi Fang¹, Ting-Wei Huang¹, Yu-Ting Cheng¹, Hsiao-En Tsai², and Yih-Shurng Chen² ¹National Yang Ming Chiao Tung University, TAIWAN and ²National Taiwan University Hospital (NTUH), TAIWAN

MP-02 ADVANCED PAPER-BASED ORGANIC ELECTROCHEMICAL TRANSISTORS: A NOVEL APPROACH FOR RAPID POINT-OF-CARE ANTIBIOTIC SUSCEPTIBILITY TESTING Zahra Rafiee, Maryam Rezaie, and Seokheun Choi State University of New York, Binghamton, USA

MP-03 DUAL-MODE SENSING PLATFORM FOR DETECTION OF INFLAMMATORY BIOMARKER IN MONITORING ORGAN TRANSPLANT REJECTION Atul Sharma, Nafize Ishtiague Hossain, and Sameer Sonkusale

Atul Sharma, Natize Ishtiaque Hossain, and Sameer Sonkusale Tufts University, USA

MP-04 EXTENDED FLIGHT DURATION SMALL-SCALE QUADROTORS POWERED BY HIGH-ENERGY-DENSITY, HIGH-POWER-DENSITY MICRO ALUMINUM-AIR BATTERIES Yanghang Huang, Haoxuan Lyu, Mark G. Allen, and Sue Ann Bidstrup Allen University of Pennsylvania, USA

MP-05 FLEXISENSE: PH-GUIDED PRECISION DRUG DELIVERY AND MONITORING USING FLEXIBLE ELECTRONIC TECHNOLOGY Akshay Krishnamumar, Masud Rana Muhammad, Sarath Gopalakrishnan, Jose Waimin, and Rahim Rahimi *Purdue University, USA*,

MP-06 INTEGRATION OF HYDROGEL MICROFIBERS FOR HYBRID LEAD SEQUESTRATION AND SENSING IN CROP PLANTS: A NOVEL APPROACH FOR PHYTOREMEDIATION Rhythem Tahrin, Francisco Perez, Mohammad Solaiman, Md Najmul Islam, Shah Zayed Riam, and Shawana Tabassum University of Texas, Tyler, USA MP-07 NFC-ENABLING SMARTPHONE-BASED PORTABLE PHOTOTHERMAL SENSING INTEGRATED WITH PAPER-BASED MICROFLUIDIC DEVICES FOR ENZYME-FREE GLUCOSE DETECTION

Kawin Khachornsakkul, Ruben Del-Rio-Ruiz, Cihan Asci, and Sameer Sonkusale *Tufts University, USA*

MP-08 PROBIOTIC-POWERED INGESTIBLE CAPSULES: A NOVEL APPROACH TO VIBRATIONAL THERAPY Maryam Rezaie and Seokheun Choi State University of New York, Binghamton, USA

MP-09 RAPID, LOW-COST CARBAPENEMASE DETECTION USING A SELF-COALESCING STICKER MICROFLUIDIC FOR ENHANCED MANAGEMENT OF CARBAPENEMASE-PRODUCING ORGANISMS IN HEALTHCARE SETTINGS Anjana Dissanayaka^{1,2}, Ali Haider³, Lily Kamat^{1,2}, Priscilla Delgado^{1,2}, Jesse Waggoner³, and David R. Myers^{1,2}

¹*Emory University, USA,* ²*Georgia Institute of Technology, USA, and* ³*Emory University School of Medicine, USA*

MP-10 FIBEROPTICS SERS BIOSENSORS FOR SALMONELLA SENSING

Mai Abuhelwa¹, Arshdeep Singh¹, Jiayu Liu¹, Mohammed Almalaysha¹, Kate E. Trout¹, Amit Morey², E. Kinzel³, Lakshmikantha H. Channaiah¹, and Mahmoud Almasri¹ ¹University of Missouri, Columbia, USA, ²Auburn University, USA, and ³University of Notre Dame, USA

MP-11 ULTRA THIN SMART ELECTROPALATOGRAPHY SYSTEM TO ASSIST LINGUISTIC AND MEDICAL DIAGNOSIS Ziqi Jia, Sunghyun Hwang, Saeyeong Jeon, Ariel David Cerpa, and Yong-Kyu "YK" Yoon University of Florida, USA

Physical Sensors, Actuators, or Systems

MP-12 2 TO 16 GHZ FUNDAMENTAL SYMMETRIC MODE ACOUSTIC RESONATORS IN PIEZOELECTRIC THIN-FILM LITHIUM NIOBATE

Vakhtang Chulukhadze, Jack Kramer, Tzu-Hsuan Hsu, Omar Barrera, Ian Anderson, Sinwoo Cho, Joshua Campbell, and Ruochen Lu *University of Texas, Austin, USA* MP-13 A LOW-PHASE NOISE OSCILLATOR EMPLOYING CONTOUR-MODE LITHIUM TANTALATE RESONATORS WITH HIGH TURNOVER TEMPERATURE

> Tanvir Hasan, Yasaman Majd, Hamed Atashbar, Hannaneh Mahdavi, Hakhamanesh Mansoorzare, and Reza Abdolvand *University of Central Florida, USA*

MP-14 A PARAMETRIC FREQUENCY COMB GENERATOR IMPROVING BY 10X THE LIMIT-OF-DETECTION OF 120 MHZ ALSCN-BASED IR DETECTORS

Hussein M. E. Hussein¹, Farah Ben Ayed², Aurelio Venditti², Pietro Simeoni², Zhenyun Qian², Cristian Cassella¹, and Matteo Rinaldi² ¹Northeastern University, USA and ²NS&NS Laboratory & Institute of NanoSystems Innovation, USA

MP-15 AI-DRIVEN SCANNING GHZ ULTRASONIC IMAGING-BASED MEMS METROLOGY

Karan Jha¹, Anuj Baskota¹, Justin Kuo¹, Serhan Ardanuç¹, Scott Zimmerman¹, and Amit Lal^{1,2} ¹Geegah Inc, USA and ²Cornell University, USA,

MP-16 CO-RESONANT CANTILEVERS AS HIGHLY SENSITIVE MASS SENSORS

Ioannis Lampouras and Julia Körner Leibniz University Hannover, GERMANY

MP-17 DESIGN AND FABRICATION OF A NOVEL THERMALLY-ACTUATED NO ELECTRIC POWER EVENT-DRIVEN MEMS SENSOR FOR IOT APPLICATIONS

Dilan Ratnayake and Kevin M. Walsh University of Louisville, USA

MP-18 DESIGN AND FABRICATION OF SWITCH BASED BIO-INSPIRED AIRFLOW SENSORS

Bram Miller, Regan Kubicek, and Sarah Bergbreiter *Carnegie Mellon University, USA*

MP-19 ENHANCING TEMPERATURE STABILITY OF LAMÉ-MODE SILICON RESONATOR USING ELASTIC NONLINEARITY Dicheng Mo, Shaurya Dabas, Banafsheh Jabbari, and Roozbeh Tabrizian

University of Florida, USA

MP-20 FLUX CONCENTRATOR OPTIMIZATION EXPLOITING SATURATION FOR MICROMACHINED AC MAGNETIC FIELD SENSORS

Xuan Wang, Sydney Sofronici, Roy H. Olsson, and Mark G. Allen *University of Pennsylvania, USA*

MP-21 GRAVIMETRIC PARTICULATE MATTER SENSING WITH PIEZOELECTRIC PAPER

Anindya L. Roy, Kanagasubbulakshmi Sankaralingam, Konrad Walus, and Boris Stoeber *University of British Columbia, CANADA*

MP-22 INTERNAL RESONANCE OF A T-SHAPED ELECTROSTATIC LEVITATION ACTUATOR

Mohammad Alzgool, Yu Tian, Mohammad Younis, and Shahrzad Towfighian *Binghamton University, USA*

MP-23 MEMS LITHIUM NIOBATE TRANSFORMER FOR LOW FREQUENCY PASSIVE GAIN WITH HIGH CAPACITIVE LOADS IN ATMOSPHERE

Justin Phelps and Reza Abdolvand *University of Central Florida, USA*

MP-24 MID-AIR PARTICLE MANIPULATIONS BY A 2x2 PMUT ARRAY

Wei Yue¹, Megan Teng¹, Yande Peng¹, Fan Xia¹, Peggy Tsao¹, Yuan Gao¹, Shinsuke Ikeuchi², Yasuhiro Aida², Seiji Umezawa², and Liwei Lin¹ ¹University of California, Berkeley, USA and ²Murata Manufacturing Co., Ltd., JAPAN,

MP-25 NONLINEAR INTERNAL RESONANCE FOR GAS SENSING

Wagner B. Lenz¹, Rodrigo T. Rocha^{1,2}, Fahimullah Khan^{1,3}, Carlos A. Grande¹, and Mohammad I. Younis^{1,4} ¹King Abdullah University of Science and Technology (KAUST), SAUDI ARABIA, ²Silicon Austria Labs (SAL), AUSTRIA, ³International Iberian Nanotechnology Laboratory Braga, PORTUGAL, and ⁴State University of New York, Binghamton, USA

MP-26 PARASITIC-IMMUNE REAL-TIME TRACKING OF A MEMS FREQUENCY REFERENCE

Jie Yan¹, Jintark Kim¹, Rakibul Islam¹, Jiheng Jing¹, Dongsuk D. Shin², Saurabh Saxena^{1,3}, Pavan Hanumolu¹, Thomas W. Kenny², and Gaurav Bahl¹ ¹University of Illinois, Urbana-Champaign, USA, ²Stanford University, USA, and ³Indian Institute of Technology, INDIA MP-27 SCANDIUM ALUMINUM NITRIDE OVERMODED BULK ACOUSTIC RESONATORS FOR FUTURE WIRELESS COMMUNICATION Walter Gubinelli, Pietro Simeoni, Ryan Tetro, Luca Colombo,

Walter Gubinelli, Pietro Simeoni, Ryan Tetro, Luca Colombo, and Matteo Rinaldi Northeastern University, USA

MP-28 SPARSE ARRAY OF THERMAL RESONATORS FOR INFRARED DETECTION AND IMAGING

Isabel H. Rodrigues¹, Clifford F. Frez¹, Savannah R. Eisner^{2,3}, Debbie G. Senesky², and Mina Rais-Zadeh¹ ¹California Institute of Technology, USA, ²Stanford University, USA, and ³Columbia University, USA

MP-29 TRAMPOLINE SI₃N₄ MAGNETOMETERS WITH 330 PT/√*Hz* SENSITIVITY Massood Tabib-Azar and Brian Baker

Massood Tabib-Azar and Brian Baker University of Utah, USA

MP-30 ULTRA-WIDEBAND TAPERED TRANSDUCERS IN THIN-FILM LITHIUM NIOBATE ON SILICON CARBIDE Jack Kramer, Tzu-Hsuan Hsu, Joshua Campbell, and Ruochen Lu University of Texas, Austin, USA

Technology, Materials, Packaging, and CAD

- MP-31 3D PRINTED MICRO LIQUID THERMAL REGULATOR (MLTR) FOR *IN-VIVO* CHRONIC PAIN APPLICATIONS Jazune Madas, Andre Childs, Jichao Ma, Jin Chen, Lei Zhai, Zixi Jack Cheng, and Swaminathan Rajaraman *University of Central Florida, USA*
- MP-32 ADVANCING MILLIMETER-WAVE TECHNOLOGIES: HIGH-EFFICIENCY 3D AIR-LIFTED INDUCTORS FEATURING A HIGHLY MANUFACTURABLE CU/CO METACONDUCTOR Saeyeong Jeon, Ariel David Cerpa, Alexander Wilcher, and Yong-Kyu Yoon University of Florida, USA

MP-33 ANALYSIS OF DIFFERENT MICROFLUIDIC PIN-FIN STRUCTURES IN METAL ADDITIVELY MICROFABRICATED PACKAGES FOR THERMAL MANAGEMENT OF MICROSYSTEMS Bhushan Lohani¹, Ryan M. Price², Peter Sanchez², and Robert C. Roberts² ¹Pennyslvania State University, USA and ²University of Texas, El Paso, USA MP-34 ENABLING CUT-RESISTANT SUPERHYDROPHOBIC SURFACES USING A HIGHLY ENTANGLED SOFT POLYMERIC SUBSTRATE

Junce Cheng and Tingyi "Leo" Liu University of Massachusetts, Amherst, USA

MP-35 HIGHLY EFFICIENT, FLEXIBLE, AND SELF-HEALABLE MOISTURE-DRIVEN ENERGY HARVESTER BASED ON 2D VANADIUM PENTOXIDE NANOSHEETS

Kundan Saha and Sameer Sonkusale Tufts University, USA

MP-36 LONG-LASTING LEVOTHYROXINE SODIUM MICRONEEDLE PATCH FOR HASHIMOTO'S THYROIDITIS TREATMENT Diana V. Rodriguez De Francisco, Edwin Davidson Barahona, Omar S. Cepeda Torres, and Swaminathan Rajaraman University of Central Florida, USA

MP-37 ON-DEMAND TRANSDERMAL DRUG DELIVERY PLATFORM BASED ON HOLLOW-GROOVE MICRONEEDLE ARRAY Jihyun Kim, Danilo M. dos Santos, Hasika Suresh, and Sameer Sonkusale *Tufts University, USA*

- MP-38 SHRINKABLE SILICONE THIN MEMBRANES AND THEIR INTEGRATION IN 3D PRINTED MICROFLUIDIC OXYGENATORS Anand Sojan, Ponnambalam Ravi Selvaganapathy and Islam Hassan McMaster University, CANADA
- MP-39 SUPERHARMONIC RESONANT RESPONSE MEASUREMENT (SRRM): A NEW METHOD FOR MEASURING SPONTANEOUS POLARIZATION

Vishnu Kumar¹, Shreeraj Joshi¹, Sudhanshu Tiwari^{1,2}, Upanya Khandelwal¹, Rudra Pratap^{1,3}, Pavan Nukala¹, and Saurabh Chandorkar¹ ¹Indian Institute of Science, Bengaluru, INDIA, ²Purdue University, USA, and ³Plaksha University, INDIA

MP-40 TAILORING ENHANCEMENT OF SILICON DIOXIDE ADHESION TO POLYCARBONATE SUBSTRATES FOR 3D MICROELECTRODE ARRAYS (3D MEAS) AND OTHER BIOSENSORS Surbhi Tidke, Omar S. Cepeda-Torres, Pablo Morales-Cruz, Brian E. Butkus, Andre Childs, and Swaminathan Rajaraman

University of Central Florida, USA

MP-41 TRANSFERRING SOFT DOUBLY RE-ENTRANT MICROSTRUCTURES FOR MECHANICALLY RESILIENT OMNIPHOBIC SURFACES

Qingyang Sun and Tingyi "Leo" Liu University of Massachusetts, Amherst, USA

Late News - Chemical or Biological Sensors, Actuators or Systems

MP-43 FLEXIBLE BIODEGRADABLE LEAF-WEARABLE SENSOR FOR MONITORING STRESS-INDUCED METHANOL EMISSION FROM PLANTS

Elvis D. Sangmen¹, A K M Sarwar Inam¹, Shah Zayed Riam¹, Md. Najmul Islam¹, Ariba Siddiqui², Mitradip Bhattacharjee², and Shawana Tabassum¹ ¹University of Texas, Tyler, USA and ²Indian Institute of Science Education and Research (IISER), INDIA

Late News - Physical Sensors, Actuators, or Systems

MP-44 INTEGRATION OF GRAPHENE-POLYMER HETEROSTRUCTURE MEMBRANES INTO A MULTI-USER MEMS FABRICATION PROCESS

Katherine Smith¹, Alaaeldin Elhady², Samed Kocer², Daniel M. Armada¹, Aidan Retallick¹, Matthias Heil¹, Eihab M. Abdel-Rahman², and Aravind Vijayaraghavan¹ ¹University of Manchester, UK, and ²University of Waterloo, CANADA

MP-45 SENSITIVITY CONSIDERATIONS FOR A SMART HYDROGEL-BASED MICROSENSOR FOR CATHETER APPLICATIONS

Benozir Ahmed¹, Christopher F. Reiche¹, Florian Solzbacher¹, and Julia Körner^{1,2} ¹University of Utah, USA and ²Leibniz University Hannover, GERMANY

MP-46 X-BAND FREQUENCY SCALING OF A0 AND S0 FOCUSED LAMB MODES FOR ACOUSTIC DELAY LINES IN 30% SCANDIUM ALUMINUM NITRIDE

Jack Guida, Gabriel Giribaldi, Matteo Rinaldi, and Siddhartha Ghosh Northeastern University, USA

Late News - Technology, Materials, Packaging, and CAD

MP-47 DEVELOPMENT OF ADVANCED DIABETIC ORTHOTICS: FROM FINITE ELEMENT MODELING TO PRESSURE SENSOR IMPLEMENTATION

Jorge Manrique Castro¹, Monisha Elumalai¹, Diana V. Rodriguez De Francisco¹, Isaac Johnson¹, Swaminathan Rajaraman¹, and Charles M. Didier^{1,2} ¹University of Central Florida, USA and ²Orthomerica Products Inc., USA

MP-48 FIRST CONTACT: DESIGN AND FABRICATION OF THE FIRST 3D PRINTED MEMS G-SWITCH

Regan Kubicek¹, Joshua Tyler², Harvey Tsang², Gabriel Smith², Daniel Jean², and Sarah Bergbreiter¹ ¹Carnegie Mellon University, USA and ²DEVCOM Army Research Laboratory, USA

MP-49 TOPOLOGICALLY PROTECTED FANO RESONANCE IN A 80 MHZ SC-DOPED ALN THIN FILM RESONATOR WITH A QUALITY FACTOR LARGER THAN 10K

Xuanyi Zhao¹, Jacopo M. De Ponti², Tommaso Maggioli¹, Marco Colangelo¹, Richard Craster³, and Cristian Cassella¹ ¹Northeastern University, USA, ²Polytechnic University of Milan, ITALY, and ³Imperial College London, UK



Poster Presentations - Session 2

Contributed and Late News Posters Wednesday, 5 June 14:30– 17:00

Chemical or Biological Sensors, Actuators or Systems

WP-01 A PIEZOELECTRIC MIDDLE-EAR MICROPHONE FOR COCHLEAR IMPLANTS

Emma F. Wawrzynek¹, John Z. Zhang¹, Ioannis Kymissis², Elizabeth S. Olson², Hideki Heidi Nakajima^{3,4}, and Jeffrey H. Lang¹ ¹Massachusetts Institute of Technology, USA, ²Columbia University, USA, ³Harvard University, USA, and ⁴Mass Eye and Ear, USA,

WP-02 AUTONOMOUS MICROFLUIDIC DEVICE FOR THE NAKED-EYE DETECTION OF BENZODIAZEPINES IN ADULTERATED BEVERAGES

Isabel Poves-Ruiz¹, Enrique Azuaje-Hualde¹, Igor Corchado-Gonzalez¹, Lourdes Basabe-Desmonts^{1,2}, and Fernando Benito-Lopez¹ ¹University of the Basque Country, SPAIN and ²IKERBASQUE, SPAIN

WP-03 ELECTROCHEMICAL SENSORS FOR HEAVY METAL DETECTION USING PYROLYTIC CARBON AND GOLD ELECTRODES

Yingming Xu, Peng Zhou, Terrence Simon, and Tianhong Cui University of Minnesota, USA

WP-04 FABRICATION OF SUBMICRON TUNABLE METAMATERIAL INFRARED ABSORBERS FOR GAS SENSING USING OPTICAL CONTACT LITHOGRAPHY

Amirali Nikeghbal, Md Rabiul Hasan, Adwait Deshpande, Fatemeh Momeni, Seungbeom Noh, Hanseup Kim, and Carlos H. Mastrangelo *University of Utah, USA*

WP-05 INTEGRATION OF HYDROGEL ADHESIVE AND MICROSTRUCTURED DEVICE FOR VAGUS NERVE STIMULATION

Jae Young Park, Jongcheon Lim, Carl R. Russell III, Pei-Lun Chen, Seokkyoon Hong, Chi Hwan Lee, and Hyowon Lee *Purdue University, USA*

WP-06 MULTIFUNCTIONAL FINGERPRINTING OF INDIVIDUAL FIBROBLASTS USING MEMS-BASED DEVICES

Ji Chang¹, Omar Cepeda-Torres¹, Saqib Shahzad¹, Guntis Rutins¹, Richard G. Blair¹, Swaminathan Rajaraman¹, and Laurene Tetard^{1,2} ¹University of Central Florida, USA and ²Universite Claude Bernard Lyon, FRANCE

WP-07 NOVEL PASSIVE INTRACRANIAL PRESSURE SENSOR USING ULTRASOUND READOUT

Colleen A. Chemerka, Juan P. Botero-Torres, Navid Farhoudi, Prattay D. Kairy, Simon Binder, Florian Solzbacher, Lars B. Laurentius, and Christopher F. Reiche *University of Utah, USA*

WP-08 RAPID POINT-OF-CARE LFA DIAGNOSTICS FOR ORAL HEALTH USING OPTICAL EXCITATION/DETECTION METHODS

Daewoo Han, Der Vang, Adewale Adehinmoye, Lyndsay Kissell, Pietro Strobbia, and Andrew J. Steckl *University of Cincinnati, USA*

WP-09 SCALABLE ELECTROPOLYMERIZATION OF VERTICAL GRAPHENE OXIDE ELECTRODES AS A PHYSICAL/CHEMICAL BIOSENSOR PLATFORM

Amani Salim¹, Farihin Adzlan¹, Haris Lotfi¹, Iman Ismail¹, Adam Zahanuddin¹, Sazwin Ishak¹, Malini Kanapathy¹, Pretha Selvam¹, Iqbal Shamsul¹, and D. Marshall Porterfield² ¹University Malaya, MALAYSIA and ²Purdue University, USA,

WP-10 TRI-COMPARTMENT CHIP WITH MICROELECTRODE ARRAY AND DR1-GLASS GROOVES FOR NEURONAL CELL ALIGNMENT

Tomi Ryynänen, Chiara Fedele, Anna-Mari Moilanen, Jorma Vihinen, Lassi Sukki, Kaisa Tornberg, Saara Haikka, Susanna Narkilahti, Arri Priimagi, and Pasi Kallio *Tampere University, FINLAND*

WP-11 VERTICAL MICRO-NANOCHANNEL INTEGRATION FOR RELATIVE SURFACE PROTEIN ABUNDANCE QUANTIFICATION ON LIPOSARCOMA EXTRACELLULAR VESICLES Premanshu K. Singh, Ali F. Usmani, Patricia Sarchet, Raphael Pollock, and Shaurya Prakash Ohio State University, USA

Physical Sensors, Actuators, or Systems

WP-12 2-SNESAT: SCALABLE BEHAVIOR-DIFFERENTIATED CONTROL FOR SWARMS OF PROGRAMMABLE MEMS MICROROBOTS

Ratul Majumdar, Milos Zefran, and Igor Paprotny University of Illinois, Chicago, USA

WP-13 A METHOD TO EXTRACT AND MODEL STRUCTURAL ASYMMETRIES IN DUAL-SHELL GYROSCOPES TO STUDY FREQUENCY DEGENERACY

Lois Meira Lopez, Danmeng Wang, Austin R. Parrish, and Andrei M. Shkel University of California, Irvine, USA

WP-14 A SELF-POWERED MICRO TRIBOELECTRIC ACCELEROMETER WITH HIGH SENSITIVITY

Mohammad Alzgool¹, Yu Tian¹, Benyamin Davaji², and Shahrzad Towfighian¹ ¹Binghamton University, USA and ²Northeastern University, USA,

WP-15 CMOS-COMPATIBLE MICROFABRICATION OF LAMINATED NIFE CORES FOR WIRELESS POWER TRANSFER

Xuan Wang, Sida Chen, Zihan Zhang, Lei Gu, and Mark G. Allen University of Pennsylvania, USA

WP-16 DEMONSTRATION OF FABRY-PEROT INTERFEROMETRY FOR PHOTOLITHOGRAPHY MASKS

Md Iftekharul Islam¹, Amrid Amnache¹, Richard Beaudry², Maurice Delafosse², Serge Ecoffey¹, and Luc G. Fréchette¹ ¹Université de Sherbrooke, CANADA and ²Digitho Technologies Inc., CANADA

WP-17 DESIGN AND FABRICATION OF LIQUID METAL TACTILE SENSORS WITH ENHANCED SENSITIVITY AND MECHANICAL ROBUSTNESS

Sung M. Kang, Andrew T. Bender, Karl F. Böhringer, Mohammad H. Malakooti, and Jonathan D. Posner *University of Washington, USA*

WP-18 EFFECT OF LOW FREQUENCY SIGNAL UP-CONVERSION ON FREQUENCY STABILITY IN CAPACITIVELY TRANSDUCED MICRORESONATORS

James M.L. Miller¹, Nicholas E. Bousse², Hyun-Keun Kwon³, Gabrielle D. Vukasin⁴, Steven W. Shaw^{5,6}, and Thomas W. Kenny² ¹*Trine University, USA, ²Stanford University, USA,* ³*Apple Incorporated, USA, ⁴Robert Bosch Research and Technology Center, USA, ⁵Florida Institute of Technology, USA, and* ⁶*Michigan State University, USA*

WP-19 FLEXIBLE ELECTROMAGNETIC ACTUATORS FOR WEARABLE HAPTIC DEVICES

Naji Tarabay¹, Ananya Renuka Balakrishna², Tianshu Liu³, Priyanshu Agarwal³, and Camilo Velez¹ ¹University of California, Irvine, USA, ²University of California, Santa Barbara, USA, and ³Meta Platforms Inc., USA

WP-20 GENERALIZED MACHINE LEARNING METHOD TO EXTRACT FREQUENCY-COMPLIANCE COEFFICIENTS FROM MEMS RESONATOR MODEL

Rahul Singaram Senthilkumar¹, Yinuo Enoch Zhao², and Xing Haw Marvin Tan³ ¹St. Joseph Institution, SINGAPORE, ²Hwa Chong Institution, SINGAPORE, and ³Agency for Science, Technology and Research (A*STAR), SINGAPORE

WP-21 IMPROVED PERFORMANCE OF PASSIVE LAYER-FREE CURVED PMUT ARRAY

Chichen Huang¹, Shubham Khandare², Sri-Rajasekhar Kothapalli², and Srinivas Tadigadapa¹ ¹Northeastern University, USA and ²Pennsylvania State University, USA,

WP-22 MAGNETICALLY COUPLED RESONATORS FOR WIRELESS POWER TRANSMISSION TO INSECT SIZED FLAPPING WING ROBOTS

Johannes M. James, Xingyi Shi, Joshua R. Smith, and Sawyer B. Fuller *University of Washington, USA*

WP-23 METHODOLOGY TO QUANTIFY CONTRIBUTION OF VARIOUS FEEDTHROUGH SOURCES IN EPI-SEALED DEVICES

Disha Chugh¹, Hyun-Keun Kwon^{2,4}, Gabrielle D. Vukasin^{3,4}, and Saurabh A Chandorkar¹ ¹Indian Institute of Science, Bangalore, INDIA, ²Centre Apple, USA, ³Robert Bosch Research and Technology Center, USA, and ⁴Stanford University, USA

WP-24 NON-RESONANT VIBRATION ENERGY HARVESTER FOR SUB-HERTZ AND SUB-G VIBRATION

Junyi Wang, Aobo Zhang, Diana Cantini, and Eun Sok Kim University of Southern California, Los Angeles, USA

WP-25 OPERATING FREQUENCY RANGES OF ULTRASOUND-BASED IMPLANTABLE GLUCOSE-SENSITIVE RESONATORS FOR IMPROVED SENSITIVITY AND LINEARITY

Prattay Deepta Kairy, Simon Binder, Navid Farhoudi, Florian Solzbacher, and Christopher F. Reiche *University of Utah, USA*

WP-26 PROBING NONLINEARITY IN SUPERLATTICE HAFNIA-ZIRCONIA-ALUMINA NANOELECTROMECHANICAL RESONATORS

S M Enamul Hoque Yousuf, Troy Tharpe, Roozbeh Tabrizian, and Philip X.-L. Feng *University of Florida, USA*

WP-27 SIMULTANEOUS DETECTION OF FLUID VISCOSITY AND DENSITY VIA PMUTS ASSISTED BY MACHINE LEARNING

Pei-Chi (Peggy) Tsao¹, Megan Teng¹, Yande Peng¹, Vivek K. Premanadhan², Ting Chen³, Samantha Averrit¹, Wei Yue¹, Jong Ha Park¹, Huicong Deng³, Fan Xia¹, Yuan Gao¹, and Liwei Lin¹ ¹University of California, Berkeley, USA, ²Synergy Marine Group, SINGAPORE, and ³University of Chinese Academy of Sciences, CHINA

WP-28 THE REALIZATION AND TESTING OF A SAPPHIRE PRESSURE SENSOR MANUFACTURED BY LASER MICROMACHINING AND THERMOCOMPRESSION BONDING

Austin L. Vera¹, David A. Mills², and Mark Sheplak¹ ¹University of Florida, USA and ²Interdisciplinary Consulting Corporation, USA,

WP-29 ULTRA-COMPACT, LOW-NOISE, AMPLITUDE-SENSITIVE AND PHASE-SENSITIVE INTEGRATED THIN-FILM GIANT MAGNETOIMPEDANCE SENSORS

Bin Luo¹, Xianfeng Liang¹, Huaihao Chen¹, Cai Müller², Paul Raschdorf², Phillip Durdaut², Michael Höft², Jeffrey McCord², and Nian X. Sun¹ ¹Northeastern University, USA and ²Kiel University, GERMANY,

Technology, Materials, Packaging, and CAD

WP-30 A 13.56 MHZ METAMATERIAL VIA THE INCORPORATION OF POLYIMIDE BASED FPCB AND NIZN FERRITE FOR WIRELESS POWER TRANSMISSION ENHANCEMENT Pin-Cheng Tseng, Mei-Syuan Wu, Wen-Hsiang Huang, Yu-Ting Cheng, Ming-Dou Ker, and Chung-Yu Wu National Yang Ming Chiao Tung University, TAIWAN

WP-31 A COMPACT ISOLATION FRAME FOR MITIGATING PACKAGING STRESS AND ANCHOR LOSS IN MICROACOUSTIC RESONATORS Maliha Sultana, Tanvir Hasan, Jennyfer Vivas Gomez, Kevin Chan, Hakhamanesh Mansoorzare, and Reza Abdolvand University of Central Florida, USA

- WP-32 AN SOI-PCB WITH THERMOCOMPRESSION BONDED CMOS, MULTILAYER WIRING, AND NATIVE MEMS Yichen Liu, Daniel Lovell, and Kristofer S.J. Pister University of California, Berkeley, USA
- WP-33 CONDUCTIVE DIRECT BONDING OF IN-SITU DOPED POLYSILICON FOR MEMS WAFER-LEVEL PACKAGING

Vincent Pares¹, Amrid Amnache¹, Romain Stricher¹, Simon Landry², Paul Gond-Charton², Thierry Courcier¹, Serge Ecoffey¹, and Luc G. Fréchette¹ ¹Université de Sherbrooke, CANADA and ²Teledyne Dalsa Semiconducteur Inc. (TDSI), CANADA,

WP-35 INCREASE IN LONGIVITY OF IMPLANTABLE NEURAL DEVICE USING NOVEL MATERIAL

Sandeep Negi^{1,2}, Christopher K. Nguyen³, David J. Warren², Stuart F. Cogan³, Florian Solzbacher², and Rajmohan Bhandari^{1,2} ¹Blackrock Neurotech, USA, ²University of Utah, USA, and ³University of Texas at Dallas, Richardson, USA

WP-36 MONOLITHIC ELECTROWETTING PRISM FOR STRUCTURED ILLUMINATION MICROSCOPY Eduardo J. Miscles¹, Catherine A. Saladrigas¹, Mo Zohrabi¹, Vikrant Kumar², Ioannis Kymissis², Juliet T. Gopinath¹, and Victor M. Bright¹ ¹University of Colorado Boulder, USA and ²Columbia University USA

²Columbia University, USA

WP-37 SELF-ALIGNED SUB 15 NANOMETER NANOGAP AND NANOWIRE FORMATION ON SAPPHIRE

Dean de Boer, Erwin Berenschot, and Niels Tas University of Twente, NETHERLANDS

WP-38 STRETCHABLE EUTECTOFIBERS VIA ROTARY WET-SPINNING FOR WEARABLE STRAIN SENSORS

Danilo M. dos Santos¹, Jihyun Kim¹, Mario B. Wyrsch^{1,2}, Mathias Bonmarin^{1,2}, and Sameer Sonkusale¹ ¹Tufts University, USA and ²Zurich University of Applied Sciences Technikumstrasse, SWITZERLAND,

WP-39 TAILORED FOREST MICRONEEDLES USING CROSS OVER LINES LASER LITHOGRAPHY FOR SIMULTANEOUS DELIVERY OF MULTIPLE DRUGS

Hasika Suresh, Danilo M. Dos Santos, Atul Sharma, Darian Myers, Sanjana Vissapragada, and Sameer Sonkusale *Tufts University, USA*

WP-40 TOWARDS A 3D PRINTED MICROFLUIDIC PIN-FIN COOLER USING TWO PHOTON POLYMERIZATION (TPP) Peter Sanchez, Ryan M. Price, and Robert C. Roberts University of Texas, El Paso, USA

WP-41 VARIABLE-SLOPE REFLECTIVE SURFACES FOR OPTICAL SYSTEM TESTING VIA NOVEL DIRECT LASER WRITING-BASED MICROREPLICATION Declan M. Fitzgerald^{1,2}, Ryan D. Sochol¹, and Anant Agrawal² ¹University of Maryland, USA and

²Food and Drug Administration, USA

Late News - Chemical or Biological Sensors, Actuators or Systems

WP-42 GLUCOSE FACTOR IN THE TEST OF ISCHEMIA HEART DISEASE FOR DIABETIC PATIENTS USING MOLECULARLY IMPRINTED POLYMER /METHYLENE BLUE SENSING ELECTRODES

Cheng-Yu Tsai¹, Yu-Ting Cheng¹, and Hsiao-En Tsai² ¹National Yang Ming Chiao Tung University, TAIWAN and ²National Taiwan University Hospital Hsin-Chu Branch, TAIWAN MP-43 MICRONEEDLE-INTEGRATED ELECTROCHEMICAL SENSOR TOWARD DETECTION OF BASOLATERAL SEROTONIN IN THE GI TRACT Sydney N. Overton, Joshua A. Levy, Michael A. Straker, Jinjing Han, and Reza Ghodssi University of Maryland, USA

Late News - Physical Sensors, Actuators, or Systems

WP-44 HIGH-QUALITY FACTOR, HIGH TCF SCANDIUM ALUMINUM NITRIDE MEMS RESONATOR FOR LOW-NOISE INFRARED SENSING Farah Ben Ayed, Aurelio Venditti, Pietro Simeoni, Zhenyun Qian,

and Matteo Rinaldi Northeastern University, USA

- WP-45 LOW-POWER THERMOMECHANICAL MODULE FOR TARGETED INGESTIBLE DEVICE BIOPSY Michael A. Straker, Joshua A. Levy, and Reza Ghodssi University of Maryland, USA
- WP-46 TEMPERATURE-INSENSITIVE 2D RESONANT GAP-BASED STRAIN SENSOR

Xintian Liu and Clark T.-C. Nguyen University of California, Berkeley, USA

Late News - Technology, Materials, Packaging, and CAD

WP-47 A SELF-AMPLIFIED SILICON-GERMANIUM NANOMECHANICAL RESONATOR WITH PIEZORESISTIVE HEAT ENGINES Faysal Hakim¹, Normarieli M. Passalacqua-Alvarado¹,

Keshab R. Sapkota², Aleem Siddiqui², Xuebin Li³, Kevin S. Jones¹, George T. Wang², and Roozbeh Tabrizian¹ ¹University of Florida, USA, ²Sandia National Laboratories, USA, and ³Applied Materials, USA

WP-48 DIRECT VAN DER WAALS INTEGRATION OF 2D MATERIALS FOR HIGH-PERFORMANCE CHEMICAL SENSORS Peter F. Satterthwaite, Sarah O. Spector, Jaekang Song, and Farnaz Niroui Massachusetts Institute of Technology, USA WP-49 MULTI-MATERIAL PALETTE FOR 3D MICROELECTRODE ARRAYS FOR A VARIETY OF 3D ELECTROGENIC MICROPHYSIOLOGICAL SYSTEMS Omar S. Cepeda Torres, Connor Edmonds, Diana V. Rodríguez De Francisco, Edwin Davidson Barahona, Charles Didier, and Swaminathan Rajaraman

University of Central Florida, USA

WP-50 ULTRA-HIGH THERMAL CONVERSION EFFICIENCY IN A PROTOTYPE LIGHT SOURCE BASED ON PHONONIC MEMS STRUCTURE

Sunghyun Hwang¹, James D. Overmeyer¹, S M Enamul Hoque Yousuf¹, William N. Carr², Philip X.-L. Feng¹, and Yong-Kyu Yoon¹ ¹University of Florida, USA and ²Phononic MEMS Inc, USA

Poster Presentations - Session 3

Commercial and Open Posters Wednesday, 5 June 18:30– 19:30

Commercial - Physical Sensors, Actuators, or Systems

WCP-51 PIEZOELECTRIC MEMS-ACTUATORS BASED ON ALSC40%N AND PZT

Yanfen Zhai^{1,2}, Andrea Bancora¹, Andrey Voloshin², Anat Siddharth², Sébastien Leni¹, and Tobias J. Kippenberg² ¹DeepLight SA, SWITZERLAND and ²Swiss Federal Institute of Technology Lausanne (EPFL), SWITZERLAND

WCP-52 SENSIBLE SENSORS WITH UNINTERRUPTED OPERATION AND UNPRECEDENTED ACCURACY Zhenyun Qian, Matteo Rinaldi, Nabid Hossain, and Kritank Kalyan Zepsor Technologies Inc., USA

Commercial - Technology, Materials, Packaging, and CAD

WCP-53 CUSTOMIZED MEMS SOLUTIONS FROM PROTOTYPE TO PRODUCTION VOLUMES Arne Leinse and Albert Prak *LioniX International, BV, NETHERLANDS*

WCP-54 DIE-TO-WAFER BONDING TECHNOLOGY FOR ADVANCED PACKAGING Viorel Dragoi, Mariana Pires, and Tobias Wernicke EV Group E. Thallner GmbH, AUSTRIA

- WCP-55 HIGH-Q MEMS RESONATORS CHARACTERIZATION BY 4D DIGITAL HOLOGRAPHIC MICROSCOPE (DHM®) Frank Liu, François Mendels, Jean-Marc Collagrossi, Shenqi Xie, and Yves Emery Lyncee Tec SA, SWITZERLAND
- WCP-56 JOIN THE IEEE MEMS TC! The IEEE MEMS Technical Community, USA
- WCP-57 MPO 100 3D LITHOGRAPHY SYSTEM FOR ADVANCING SENSORS AND ACTUATORS RESEARCH Yashica Brown, Benedikt Stender, and Willi Mantei Heidelberg Instruments, USA
- WCP-58 THE COMPLETE DESIGN-TO-PRODUCTION SOLUTION FOR PZT MEMS

Andrew O. Fung¹, Mario Kiuchi², Gen Matsuoka², Tsuyoshi Takemoto², and Alissa M. Fitzgerald¹ ¹A.M. Fitzgerald & Associates, LLC, USA and ²Sumitomo Precision Products Co., Ltd., JAPAN

WCP-59 BIOCOASTAL INSTITUTE FOR NANOSYSTEMS INNOVATION (NANOSI) LAUNCHES AT NORTHEASTERN UNIVERSITY Matteo Rinaldi and David Horsley Northeastern University, USA

Open Posters

WOP-01 A PCB BASED, LOW-COST, MEMS TACTILE DISPLAY FOR BRAILLE AND IMAGES Jonathan Bernstein¹, Maijie Xiang², and Robert White²

¹Draper, USA and ²Tufts University, USA

- WOP-02 ADVANCED MANUFACTURING LABORATORY AT THE UNIVERSITY OF MARYLAND Sydney N. Overton¹, Weijian Xian¹, Justin M. Stine¹, Jinjing Han¹, Kevin M. Daniels¹, and Reza Ghodssi¹ University of Maryland, USA
- WOP-03 BIOAERIUM : UBIQUITOUS MULTI-PATHOGEN SENSING FROM AIR USING NUCLEIC ACID AMPLIFICATION Nitin Jayakumar, Michael Caffrey, and Igor Paprotny University of Illinois at Chicago, USA

WOP-04 CAPSULE SYSTEM TOWARD REAL-TIME ELECTROCHEMICAL DETECTION OF HYDROGEN SULFIDE IN THE GI TRACT Justin M. Stine¹, Katie L. Ruland¹, Joshua A. Levy¹, Luke A. Beardslee¹, Pankaj J. Pasricha², and Reza Ghodssi¹ ¹University of Maryland, USA and ²Mayo Clinic Hospital, USA

WOP-05 HIGH POWER MEMS OHMIC CONTACT FROM DC TO MILLIMETER WAVE Xu Zhu, Nicole D. Kerness, and Chris F. Keimel Menlo Micro. USA

- WOP-06 MEMS MEETS MAGNONICS Sudhanshu Tiwari¹, Anuj Ashok¹, Connor James Devitt¹, Wang Renyuan², and Sunil Bhave¹ ¹Purdue University, USA and ²BAE Systems, USA
- WOP-07 MICROSCALE PH GENERATION ON DEMAND: A PLATFORM FOR TUNING BIOMOLECULAR REACTIVITY Nadia Fomina, Christopher Johnson, Young Shik Shin, Gabrielle Vukasin, and Christoph Lang Robert Bosch Research and Technology Center, USA

WOP-08 NANOFRAZOR TECHNOLOGY - FABRICATING ADVANCED 2D AND GRAYSCALE STRUCTURES USING THERMAL SCANNING PROBE LITHOGRAPHY AND DIRECT LASER SUBLIMATION Nicholas Hendricks, Julia Stark, Myriam Käppeli, Jana Chaaban, and Emine Çağin Heidelberg Instruments Nano AG, SWITZERLAND

WOP-09 NANOSTRUCTURING GRAPHENE ON SILICON FOR ENHANCED SEMICONDUCTOR INTERCONNECTS Amani Salim, Adam Zahanuddin, Farihin Adzlan, Pretha Selvam, and Iqbal Shamsul nanoSkunkWorkX, MALAYSIA

WOP-10 NEAR-ZERO STIFFNESS MEMS ACCELEROMETER WITH BUCKLING OF TUNABLE ELECTROTHERMAL MICROBEAMS Chen Wang¹, Hussein Hussein², Rui Amendoeira Esteves¹, Hossein Fariborzi³, and Michael Kraft¹ ¹KU Leuven, BELGIUM, ²American University of Beirut, LEBANON, and ³King Abdullah University of Science and Technology, SAUDI ARABIA

WOP-11 NIH BRAIN BEHAVIOR QUANTIFICATION AND SYNCHRONIZATION SENSORS PROGRAM Yvonne Bennett

National Institute of Mental Health, USA

- WOP-12 QUADRUPLE MASS GYROSCOPE ANGLE RANDOM WALK REDUCTION THROUGH LINEARIZED TRANSDUCTION Ryan Knight¹, Ryan Rudy¹, Jeffrey Pulskamp¹, Robert Benoit¹, Don DeVoe², and Esmond Lau³ ¹DEVCOM Army Research Laboratory, USA, ²University of Maryland, USA, and ³Oak Ridge Associated Universities, USA
- WOP-13 QUARTZ MEMS GYROSCOPES FOR INERTIAL NAVIGATION Andrei M. Shkel, Austin R. Parrish, Eudald Sangenis, Lois Meira Lopez, Crystal Wai, and Amin Ebrahimzadeh University of California, Irvine, USA
- WOP-14 TOWARD MM-WAVE ACOUSTIC VIBRATION MEASUREMENTS WITH PULSED LASER INTERFEROMETRY Marvin Schewe and Jason J. Gorman *NIST. USA*



NOTES

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MONTRÉA	TIONAL CONFERENCE O MS FOR CHEMISTRY AN L, CANAD ENARY SPEAKE	D LIFE SCIENCES
Altug Hatice	Ulf Landegren	Jennifer Lewis
EPFL, SWITZERLAND	Uppsala University, SWEDEN	Harvard University, USA
Bin Liu	Dennis Lo	John A. Rogers
National University of Singapore, SINGAPORE	24 CE Chemical	Northwestern University, USA
		CONFERENCE CHAIRS David Juncker McGill University, CANADA Aaron Wheeler University of Toronto, CANADA ww.microtas2024.org





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